## features

- 600ksps ADC with 6 Simultaneously Sampled Differential Inputs
- 100ksps Throughput per Channel
- 72dB SINAD
- Low Power Dissipation: 15mW
- 3V Single Supply Operation
- 2.5V Internal Bandgap Reference, Can be Overdriven with External Reference
- 3-Wire SPI-Compatible Serial Interface
- OV to 2.5V Unipolar, or $\pm 1.25 \mathrm{~V}$ Bipolar Differential Input Range
- SLEEP ( $6 \mu \mathrm{~W}$ ) Shutdown Mode
- NAP (3.3mW) Shutdown Mode
- Internal Conversion Triggered by CONV
- 83dB Common Mode Rejection
- Tiny $32-$ Pin $(5 \mathrm{~mm} \times 5 \mathrm{~mm})$ QFN Package


## APPLICATIONS

- Multiphase Power Measurement
- Multiphase Motor Control
- Data Acquisition Systems
- Uninterruptable Power Supplies
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## DESCRIPTIO

The LTC ${ }^{\circledR} 1408-12$ is a 12 -bit, 600 ksps ADC with six simultaneously sampled differential inputs. The device draws only 5 mA from a single 3 V supply, and comes in a tiny 32 pin ( $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ ) QFN package. A SLEEP shutdown feature further reduces power consumption to $6 \mu \mathrm{~W}$. The combination of low power and tiny package makes the LTC1408-12 suitable for portable applications.
The LTC1408-12 contains six separate differential inputs that are sampled simultaneously on the rising edge of the CONV signal. These six sampled inputs are then converted at a rate of 100 ksps per channel.
The 83dB common mode rejection allows users to eliminate ground loops and common mode noise by measuring signals differentially from the source.
The device converts 0 V to 2.5 V unipolar inputs differentially, or $\pm 1.25 \mathrm{~V}$ bipolar inputs also differentially, depending on the state of the BIP pin. Any analog input may swing rail-to-rail as long as the differential input range is maintained.
The conversion sequence can be abbreviated to convert fewer than six channels, depending on the logic state of the SEL2, SEL1 and SEL0 inputs.
The serial interface sends out the six conversion results in 96 clocks for compatibility with standard serial interfaces.

BLOCK DIAGRAM


## absolute maximum ratings

(Notes 1, 2)
Supply Voltage ( $\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{CC}}, \mathrm{OV}_{\mathrm{DD}}$ ) .............................. 4V
Analog and $V_{\text {REF }}$ Input Voltages
(Note 3)
-0.3 V to $(\mathrm{VDD}+0.3 \mathrm{~V})$
Digital Input Voltages ................. -0.3 V to $\left(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\right)$
Digital Output Voltage .................. -0.3 V to $\left(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\right)$
Power Dissipation 100 mW
Operation Temperature Range
LTC1408C-12 $.0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
LTC1408I-12 $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
Storage Temperature Range ................ $-65^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$

PACKAGE/ORDER INFORMATION


Consult LTC Marketing for parts specified with wider operating temperature ranges.

CONVERTER CHARACTERISTICS
The $\bullet$ denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. With internal reference, $\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{C C}=3 \mathrm{~V}$.

| PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Resolution (No Missing Codes) |  | $\bullet$ | 12 |  |  | Bits |
| Integral Linearity Error | (Note 5) | $\bullet$ | -1 | $\pm 0.25$ | 1 | LSB |
| Offset Error | (Note 4) | $\bullet$ | -4.5 | $\pm 1$ | 4.5 | mV |
| Offset Match from CH0 to CH5 |  |  | -3 | $\pm 0.5$ | 3 | mV |
| Range Error | (Note 4) | $\bullet$ | -12 | $\pm 2$ | 12 | mV |
| Range Match from CH 0 to CH 5 |  |  | -5 | $\pm 1$ | 5 | mV |
| Range Tempco | Internal Reference (Note 4) External Reference |  |  | $\begin{gathered} \pm 15 \\ \pm 1 \end{gathered}$ |  | $\begin{aligned} & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \end{aligned}$ |

## AחALOG InPUT

The • denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_{A}=25^{\circ} \mathrm{C}$. With internal reference, $\mathrm{V}_{D D}=\mathrm{V}_{C C}=3 \mathrm{~V}$.

| SYMBOL | PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {IN }}$ | Analog Differential Input Range (Notes 3, 8, 9) | $2.7 \mathrm{~V} \leq \mathrm{V}_{\mathrm{DD}} \leq 3.3 \mathrm{~V}$ |  |  | 0 to 2.5 |  | V |
| $\mathrm{V}_{\text {CM }}$ | Analog Common Mode + Differential Input Range | (Note 8) |  |  | 0 to $V_{\text {D }}$ |  | V |
| $\mathrm{I}_{\text {N }}$ | Analog Input Leakage Current |  | - |  |  | 1 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {IN }}$ | Analog Input Capacitance |  |  |  | 13 |  | pF |
| ${ }^{\text {t }}$ ACQ | Sample-and-Hold Acquisition Time | (Note 6) | $\bullet$ |  |  | 39 | ns |
| $\mathrm{t}_{\text {AP }}$ | Sample-and-Hold Aperture Delay Time |  |  |  | 1 |  | ns |
| $\mathrm{t}_{\text {JITTER }}$ | Sample-and-Hold Aperture Delay Time Jitter |  |  |  | 0.3 |  | ps |
| $\mathrm{t}_{\text {SK }}$ | Channel to Channel Aperture Skew |  |  |  | 200 |  | ps |
| CMRR | Analog Input Common Mode Rejection Ratio | $\begin{aligned} & f_{I N}=100 \mathrm{kHz}, V_{I N}=0 \mathrm{~V} \text { to } 3 \mathrm{~V} \\ & \mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}, \mathrm{~V}_{\text {IN }}=0 \mathrm{~V} \text { to } 3 \mathrm{~V} \end{aligned}$ |  |  | $\begin{aligned} & -83 \\ & -67 \end{aligned}$ |  | dB dB |
|  |  |  |  |  |  |  | 140812 f |

 otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. With internal reference, $\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}$.

| SYMBOL | PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SINAD | Signal-to-Noise Plus Distortion Ratio | 100kHz Input Signal 300kHz Input Signal | $\bullet$ | 70 | $\begin{aligned} & 72 \\ & 72 \end{aligned}$ |  | dB dB |
| THD | Total Harmonic Distortion | 100kHz First 5 Harmonics 300kHz First 5 Harmonics | $\bullet$ | -80 | $\begin{aligned} & \hline-90 \\ & -86 \end{aligned}$ |  | dB dB |
| SFDR | Spurious Free Dynamic Range | 100 kHz Input Signal 300kHz Input Signal |  |  | $\begin{aligned} & 90 \\ & 86 \end{aligned}$ |  | dB dB |
| IMD | Intermodulation Distortion | $0.625 \mathrm{~V}_{\text {P-p }}, 833 \mathrm{kHz}$ into $\mathrm{CHO}+, 0.625 \mathrm{~V}_{\text {P-p }}, 841 \mathrm{kHz}$ into CHO Bipolar Mode. Also Applicable to Other Channels |  |  | -80 |  | dB |
|  | Code-to-Code Transition Noise | $\mathrm{V}_{\text {REF }}=2.5 \mathrm{~V}$ (Note 17) |  |  | 0.2 |  | $\mathrm{LSB}_{\text {RMS }}$ |
|  | Full Power Bandwidth | $\mathrm{V}_{\text {IN }}=2.5 \mathrm{~V}_{\text {P-P, }}$ SDO $=11585 \mathrm{LSB} \mathrm{P}_{\text {P-P }}(-3 \mathrm{dBFS})($ Note 15) |  |  | 50 |  | MHz |
|  | Full Linear Bandwidth | $\mathrm{S} /(\mathrm{N}+\mathrm{D}) \geq 68 \mathrm{~dB}$, Bipolar Differential Input |  |  | 5 |  | MHz |



| PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {REF }}$ Output Voltage | $\mathrm{I}_{\text {OUT }}=0$ |  | 2.5 |  | V |
| $\mathrm{V}_{\text {REF }}$ Output Tempco |  |  | 15 |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| $V_{\text {REF }}$ Line Regulation | $\mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}$ to 3.6V, $\mathrm{V}_{\text {REF }}=2.5 \mathrm{~V}$ |  | 600 |  | $\mu \mathrm{V} / \mathrm{N}$ |
| $V_{\text {REF }}$ Output Resistance | Load Current $=0.5 \mathrm{~mA}$ |  | 0.2 |  | $\Omega$ |
| $V_{\text {REF }}$ Settling Time | $C_{\text {REF }}=10 \mu \mathrm{~F}$ |  | 2 |  | ms |
| External $\mathrm{V}_{\text {REF }}$ Input Range |  | 2.55 |  | $V_{D D}$ | V |

## DIGITAL InPUTS AחD DIGITAL OUTPUTS The e denotes the speciificaitions which apply ver the full operating temperature range, otherwise specifications are at $T_{A}=25^{\circ} C . V_{D D}=V_{C C}=3 \mathrm{~V}$.

| SYMBOL | PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IH }}$ | High Level Input Voltage | $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}$ | $\bullet$ | 2.4 |  |  | V |
| VIL | Low Level Input Voltage | $V_{D D}=2.7 \mathrm{~V}$ | $\bullet$ |  |  | 0.6 | V |
| $\mathrm{I}_{\text {IN }}$ | Digital Input Current | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}$ | $\bullet$ |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {IN }}$ | Digital Input Capacitance |  |  |  | 5 |  | pF |
| $\mathrm{V}_{\mathrm{OH}}$ | High Level Output Voltage | $V_{D D}=3 \mathrm{~V}, \mathrm{I}_{0 U T}=-200 \mu \mathrm{~A}$ | $\bullet$ | 2.5 | 2.9 |  | V |
| $\mathrm{V}_{\text {OL }}$ | Low Level Output Voltage | $\begin{aligned} & V_{D D}=2.7 \mathrm{~V}, I_{\text {OUT }}=160 \mu \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=1.6 \mathrm{~mA} \end{aligned}$ | $\bullet$ |  | 0.05 | 0.4 | V |
| $\mathrm{I}_{0 Z}$ | Hi-Z Output Leakage $\mathrm{D}_{\text {OUT }}$ | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ and $\mathrm{V}_{\text {DD }}$ | $\bullet$ |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| $\mathrm{C}_{02}$ | Hi-Z Output Capacitance Dout |  |  |  | 1 |  | pF |
| I SOURCE | Output Short-Circuit Source Current | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}, \mathrm{~V}_{\text {DD }}=3 \mathrm{~V}$ |  |  | 20 |  | mA |
| $\mathrm{I}_{\text {SINK }}$ | Output Short-Circuit Sink Current | $V_{\text {OUT }}=V_{\text {DD }}=3 \mathrm{~V}$ |  |  | 15 |  | mA |

POUER RESUIREMEMTS The • denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. With internal reference, $\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\mathrm{C}}=3 \mathrm{~V}$.

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $V_{D D}, V_{C C}$ | Supply Voltage |  | 2.7 | 3.0 | 3.6 | V |
| $I_{D D}+I_{C C}$ | Supply Current | Active Mode, $\mathrm{f}_{\text {SAMPLE }}=600 \mathrm{ksps}$ |  | 5 | 7 | mA |
|  |  | Nap Mode | $\bullet$ | 1.1 | 1.9 | mA |
|  |  | Sleep Mode | 2.0 | 15 | $\mu \mathrm{~A}$ |  |
| PD | Power Dissipation | Active Mode with SCK, $\mathrm{f}_{\text {SAMPLE }}=600 \mathrm{ksps}$ |  | 15 | mW |  |

TIIIRC CHARACTERISTMCS The o denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_{A}=25^{\circ} \mathrm{C}$. $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}$.

| SYMBOL | PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {SAMPLE(MAX) }}$ | Maximum Sampling Rate per Channel (Conversion Rate) |  | - | 100 |  |  | kHz |
| ${ }_{\text {t }}$ throughput | Minimum Sampling Period (Conversion + Acquisiton Period) |  | $\bullet$ |  |  | 10 | $\mu \mathrm{S}$ |
| tsck | Clock Period | (Note 16) | $\bullet$ | 100 |  | 10000 | ns |
| $\mathrm{t}_{\text {CONV }}$ | Conversion Time | (Notes 6, 17) |  | 96 |  |  | SCLK cycles |
| $\mathrm{t}_{1}$ | Minimum High or Low SCLK Pulse Width | (Note 6) |  | 2 |  |  | ns |
| $\mathrm{t}_{2}$ | CONV to SCK Setup Time | (Notes 6, 10) |  | 3 |  | 10000 | ns |
| $\mathrm{t}_{3}$ | SCK Before CONV | (Note 6) |  | 0 |  |  | ns |
| $\mathrm{t}_{4}$ | Minimum High or Low CONV Pulse Width | (Note 6) |  | 4 |  |  | ns |
| $t_{5}$ | SCK $\uparrow$ to Sample Mode | (Note 6) |  | 4 |  |  | ns |
| $\mathrm{t}_{6}$ | CONV $\uparrow$ to Hold Mode | (Notes 6, 11) |  | 1.2 |  |  | ns |
| $\mathrm{t}_{7}$ | 96th SCK个 to CONV $\uparrow$ Interval (Affects Acquisition Period) | (Notes 6, 7, 13) |  | 45 |  |  | ns |
| $\mathrm{t}_{8}$ | Delay from SCKto Valid Bits 0 Through 11 | (Notes 6, 12) |  |  |  | 8 | ns |
| $\mathrm{t}_{9}$ | SCK $\uparrow$ to Hi-Z at SDO | (Notes 6, 12) |  |  |  | 6 | ns |
| $\mathrm{t}_{10}$ | Previous SDO Bit Remains Valid After SCK | (Notes 6, 12) |  | 2 |  |  | ns |
| $\mathrm{t}_{11}$ | $V_{\text {ReF }}$ Settling Time After Sleep-to-Wake Transition | (Notes 6, 14) |  |  | 2 |  | ms |

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliabilty and lifetime.
Note 2: All voltage values are with respect to ground GND.
Note 3: When these pins are taken below GND or above $V_{D D}$, they will be clamped by internal diodes. This product can handle input currents greater than 100 mA below $G N D$ or greater than $V_{D D}$ without latchup.
Note 4: Offset and range specifications apply for a single-ended $\mathrm{CHO}^{+}-$ $\mathrm{CH}^{+}$input with $\mathrm{CHO}^{-}-\mathrm{CH}^{-}$grounded and using the internal 2.5 V reference.
Note 5: Integral linearity is tested with an external 2.55 V reference and is defined as the deviation of a code from the straight line passing through the actual endpoints of a transfer curve. The deviation is measured from the center of quantization band. Linearity is tested for CHO only.
Note 6: Guaranteed by design, not subject to test.
Note 7: Recommended operating conditions.
Note 8: The analog input range is defined for the voltage difference between $\mathrm{CHx}^{+}$and $\mathrm{CHx}^{-}, \mathrm{x}=0-5$.

Note 9: The absolute voltage at $\mathrm{CHx}^{+}$and $\mathrm{CHx}^{-}$must be within this range.
Note 10: If less than 3ns is allowed, the output data will appear one clock cycle later. It is best for CONV to rise half a clock before SCK, when running the clock at rated speed.
Note 11: Not the same as aperture delay. Aperture delay (1ns) is the difference between the 2.2 ns delay through the sample-and-hold and the 1.2ns CONV to Hold mode delay.

Note 12: The rising edge of SCK is guaranteed to catch the data coming out into a storage latch.
Note 13: The time period for acquiring the input signal is started by the 96th rising clock and it is ended by the rising edge of CONV.
Note 14: The internal reference settles in 2 ms after it wakes up from Sleep mode with one or more cycles at SCK and a $10 \mu \mathrm{~F}$ capacitive load.
Note 15: The full power bandwidth is the frequency where the output code swing drops by 3 dB with a $2.5 \mathrm{~V}_{\mathrm{P}-\mathrm{p}}$ input sine wave.
Note 16: Maximum clock period guarantees analog performance during conversion. Output data can be read with an arbitrarily long clock period.
Note 17: The conversion process takes 16 clocks for each channel that is enabled, up to 96 clocks for all 6 channels.

## TYPICAL PGRFORMANCE CHARACTERISTICS $\mathrm{v}_{\mathrm{DO}}=3 \mathrm{JV}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$



## TYPICAL PGRFORMAOCE CHARACTGRISTICS $\mathrm{v}_{00}=3 V, T_{A}=25^{\circ} \mathrm{C}$



## Crosstalk vs Frequency




PSRR vs Frequency


## PIn functions

SDO (Pin 1): Three-State Serial Data Output. Each set of six output data words represent the six analog input channels at the start of the previous conversion. Data for CHO comes out first and data for CH 5 comes out last. Each data word comes out MSB first.

OGND (Pin 2): Ground Return for SDO Currents. Connect to the solid ground plane.
$\mathrm{OV}_{D D}$ (Pin 3): Power Supply for the SDO Pin. OV $\mathrm{V}_{D D}$ must be no more than 300 mV higher than $V_{D D}$ and can be brought to a lower voltage to interface to low voltage logic families. The unloaded high state at SDO is at the potential of $\mathrm{O}_{\mathrm{DD}}$.
$\mathrm{CHO}^{+}$(Pin 4): Non-Inverting Channel $0 . \mathrm{CH}^{+}$operates fully differentially with respect to $\mathrm{CHO}^{-}$with a OV to 2.5 V , or $\pm 1.25 \mathrm{~V}$ differential swing and a OV to $\mathrm{V}_{\mathrm{DD}}$ absolute input range.
$\mathrm{CHO}^{-}$(Pin 5 ): Inverting Channel $0 . \mathrm{CHO}^{-}$operates fully differentially with respect to $\mathrm{CH}^{+}$with a -2.5 V to OV , or $\pm 1.25 \mathrm{~V}$ differential swing and a OV to $\mathrm{V}_{\mathrm{DD}}$ absolute input range.
GND (Pins 6, 9, 12, 13, 16, 19): Analog Grounds. These ground pins must be tied directly to the solid ground plane under the part. Analog signal currents flow through these connections.
CH1+ (Pin 7): Non-Inverting Channel 1. $\mathrm{CH}^{+}$operates fully differentially with respect to $\mathrm{CH}^{-}$with a OV to 2.5 V , or $\pm 1.25 \mathrm{~V}$ differential swing and a OV to $\mathrm{V}_{\mathrm{DD}}$ absolute input range.
CH1- (Pin 8): Inverting Channel 1. $\mathrm{CH1}^{-}$operates fully differentially with respect to $\mathrm{CH}^{+}$with a -2.5 V to OV , or $\pm 1.25 \mathrm{~V}$ differential swing and a OV to $\mathrm{V}_{\mathrm{DD}}$ absolute input range.
$\mathrm{CH}^{+}$(Pin 10): Non-Inverting Channel 2. $\mathrm{CH}^{+}$operates fully differentially with respect to $\mathrm{CH}^{-}$with a OV to 2.5 V , or $\pm 1.25 \mathrm{~V}$ differential swing and a OV to $\mathrm{V}_{\mathrm{DD}}$ absolute input range.
CH2 $^{-}$(Pin 11): Inverting Channel 2. CH2 $^{-}$operates fully differentially with respect to $\mathrm{CH} 2^{+}$with a -2.5 V to OV , or $\pm 1.25 \mathrm{~V}$ differential swing and a 0 V to $\mathrm{V}_{\mathrm{DD}}$ absolute input range.

CH3 ${ }^{+}$(Pin 14): Non-Inverting Channel 3. $\mathrm{CH}^{+}$operates fully differentially with respect to $\mathrm{CH3}^{-}$with a OV to 2.5 V , or $\pm 1.25 \mathrm{~V}$ differential swing and a 0 V to $\mathrm{V}_{\mathrm{DD}}$ absolute input range.
CH3- (Pin 15): Inverting Channel 3. CH3$^{-}$operates fully differentially with respect to $\mathrm{CH}^{+}$with a -2.5 V to OV , or $\pm 1.25 \mathrm{~V}$ differential swing and a OV to $\mathrm{V}_{\mathrm{DD}}$ absolute input range.
CH4 ${ }^{+}$(Pin 17): Non-Inverting Channel 4. CH4+ operates fully differentially with respect to $\mathrm{CH}^{-}$with a OV to 2.5 V , or $\pm 1.25 \mathrm{~V}$ differential swing and OV to $\mathrm{V}_{D D}$ absolute input range.
CH4- (Pin 18): Inverting Channel 4. CH4- operates fully differentially with respect to $\mathrm{CH} 4^{+}$with a -2.5 V to OV , or $\pm 1.25 \mathrm{~V}$ differential swing and OV to $\mathrm{V}_{\mathrm{DD}}$ absolute input range.
CH5 ${ }^{+}$(Pin 20): Non-Inverting Channel 5. CH5 ${ }^{+}$operates fully differentially with respect to $\mathrm{CH5}^{-}$with a OV to 2.5 V , or $\pm 1.25 \mathrm{~V}$ differential swing and OV to $\mathrm{V}_{D D}$ absolute input range.
CH5- (Pin 21): Inverting Channel 5. CH5- operates fully differentially with respect to $\mathrm{CH} 5^{+}$with a -2.5 V to OV , or $\pm 1.25 \mathrm{~V}$ differential swing and a OV to $\mathrm{V}_{\mathrm{DD}}$ absolute input range.
GND (PIN 22): Analog Ground for Reference. Analog ground must be tied directly to the solid ground plane under the part. Analog signal currents flow through this connection. The $10 \mu \mathrm{~F}$ reference bypass capacitor should be returned to this pad.
$\mathrm{V}_{\text {REF }}$ (Pin 23): 2.5V Internal Reference. Bypass to GND and a solid analog ground plane with a $10 \mu \mathrm{~F}$ ceramic capacitor (or $10 \mu \mathrm{~F}$ tantalum in parallel with $0.1 \mu \mathrm{~F}$ ceramic). Can be overdriven by an external reference voltage between 2.55 V and $\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{CC}}$.
$\mathrm{V}_{\text {cc }}$ (Pin 24): 3V Positive Analog Supply. This pin supplies $3 V$ to the analog section. Bypass to the solid analog ground plane with a $10 \mu \mathrm{~F}$ ceramic capacitor (or $10 \mu \mathrm{~F}$ tantalum) in parallel with $0.1 \mu \mathrm{~F}$ ceramic. Care should be taken to place the 0.1 fF bypass capacitor as close to Pin 24 as possible. Pin 24 must be tied to Pin 25 .

## PIn functions

$V_{D D}$ (Pin 25): 3V Positive Digital Supply. This pin supplies 3 V to the logic section. Bypass to DGND pin and solid analog ground plane with a $10 \mu \mathrm{~F}$ ceramic capacitor (or $10 \mu \mathrm{~F}$ tantalum in parallel with $0.1 \mu \mathrm{~F}$ ceramic). Keep in mind that internal digital output signal currents flow through this pin. Care should be taken to place the $0.1 \mu \mathrm{~F}$ bypass capacitor as close to Pin 25 as possible. Pin 25 must be tied to Pin 24.

SEL2 (Pin 26): Most significant bit controlling the number of channels being converted. In combination with SEL1 and SELO, 000 selects just the first channel (CHO) for conversion. Incrementing SELx selects additional channels(CH0-CH5) for conversion. 101, 110 or 111 select all 6 channels for conversion. Must be kept in a fixed state during conversion and during the subsequent conversion to read data.

SEL1 (Pin 27): Middle significance bit controlling the number of channels being converted. In combination with SELO and SEL2, 000 selects just the first channel (CHO) for conversion. Incrementing SELx selects additional channels for conversion. 101, 110 or 111 select all 6 channels (CHO-CH5) for conversion. Must be kept in a fixed state during conversion and during the subsequent conversion to read data.

SELO (Pin 28): Least significant bit controlling the number of channels being converted. In combination with SEL1 and SEL2, 000 selects just the first channel (CHO) for conversion. Incrementing SELx selects additional channels for conversion. 101, 110 or 111 select all 6 channels (CHO-CH5) for conversion. Must be kept in a fixed state during conversion and during the subsequent conversion to read data.

BIP (Pin 29): Bipolar/Unipolar Mode. The input differential range is $0 \mathrm{~V}-2.5 \mathrm{~V}$ when BIP is LOW , and it is $\pm 1.25 \mathrm{~V}$ when BIP is HIGH. Must be kept in fixed state during conversion and during subsequent conversion to read data. When changing BIP between conversions the full acquisition time must be allowed before starting the next conversion. The output data is in 2's complement format for bipolar mode and straight binary format for unipolar mode.
CONV (Pin 30): Convert Start. Holds the six analog input signals and starts the conversion on CONV's rising edge. Two CONV pulses with SCK in fixed high or fixed Iow state starts Nap mode. Four or more CONV pulses with SCK in fixed high or fixed low state starts Sleep mode.
DGND (Pin 31): Digital Ground. This ground pin must be tied directly to the solid ground plane. Digital input signal currents flow through this pin.

SCK (Pin 32): External Clock Input. Advances the conversion process and sequences the output data at SD0 (Pin1) on the rising edge. One or more SCK pulses wake from sleep or nap power saving modes. 16 clock cycles are needed for each of the channels that are activated by SELx (Pins 26, 27, 28), up to a total of 96 clock cycles needed to convert and read out all 6 channels.

EXPOSED PAD (Pin 33): GND. Must be tied directly to the solid ground plane.

## BLOCK DIAGRAM






## timing DIAGRAms

Nap Mode and Sleep Mode Waveforms


SCK to SDO Delay


## APPLICATIONS InFORMATION

SELECTING THE NUMBER OF CONVERTED CHANNELS (SEL2, SEL1, SELO)

These three control pins select the number of channels being converted (see Table 1). 000 selects only the first channel (CHO) for conversion. Incrementing SELx selects additional channels for conversion, up to 6 channels. 101, 110 or 111 select all 6 channels for conversion. These pins must be kept in a fixed state during conversion and during the subsequent conversion to read data. When changing modes between conversions, keep in mind that the output data of a particular channel will remain unchanged until after that channel is converted again. For example: convert a sequence of 4 channels (CH0, CH1, CH2, CH3) with SELX $=011$, then, after these channels are converted change SELx to 001 to convert just CHO and CH 1 . During the conversion of the first set of two channels you will be able to read the data from the same two channels converted as part of the previous group of 4 channels. Later, you could convert 4 or more channels to read back the unread CH 2 and CH 3 data that was converted in the first set of 4 channels. These pins are often hardwired to enable the right number of channels for a particular application. Choosing to convert fewer channels per conversion results in faster throughput of those channels. For example, 6 channels can be converted at $100 \mathrm{ksps} / \mathrm{ch}$, while 3 channels can be converted at $200 \mathrm{ksps} / \mathrm{ch}$.

## BIPOLAR/UNIPOLAR MODE

The input voltage range for each of the CHx input differential pairs is UNIPOLAR OV - 2.5V when BIP is LOW, and BIPOLAR $\pm 1.25 \mathrm{~V}$ when BIP is HIGH. This pin must be kept in fixed state during conversion and during subsequent conversion to read data. When changing BIP between conversions the full acquisition time must be allowed before starting the next conversion. After changing modes from BIPOLAR to UNIPOLAR, or from UNIPOLAR to BIPOLAR, you can still read the first set of channels in the new mode, by inverting the MSB to read these channels in the mode that they were converted in.

## DRIVING THE ANALOG INPUT

The differential analog inputs of the LTC1408-12 may be driven differentially or as a single-ended input (i.e., the $\mathrm{CHx}^{-}$input is grounded). All twelve analog inputs of all six differential analog input pairs, $\mathrm{CH}^{+}$and $\mathrm{CHO}^{-}, \mathrm{CH}^{+}$and $\mathrm{CH}^{-}, \mathrm{CH}^{+}$and $\mathrm{CH}^{-}, \mathrm{CH}^{+}$and $\mathrm{CH}^{-}, \mathrm{CH}^{+}$and $\mathrm{CH}^{-}$ and $\mathrm{CH}^{+}$and $\mathrm{CH}^{-}$, are sampled at the same instant. Any unwanted signal that is common to both inputs of each input pair will be reduced by the common mode rejection of the sample-and-hold circuit. The inputs draw only one small current spike while charging the sample-and-hold capacitors at the end of conversion. During conversion, the analog inputs draw only a small leakage current. If the source impedance of the driving circuit is low, then the

Table 1. Conversion Sequence Control
("acquire" represents simultaneous sampling of all channels; CHx represents conversion of channels)

| SEL2 | SEL1 | SELO | CHANNEL ACQUISITION AND CONVERSION SEQUENCE |
| :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | acquire, CH 0 , acquire, CHO ... |
| 0 | 0 | 1 | acquire, $\mathrm{CHO}, \mathrm{CH} 1$, acquire, $\mathrm{CH} 0, \mathrm{CH1} . .$. |
| 0 | 1 | 0 | acquire, $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2$, acquire, $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2 . .$. |
| 0 | 1 | 1 | acquire, $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2, \mathrm{CH} 3$, acquire, $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2, \mathrm{CH} 3 .$. |
| 1 | 0 | 0 | acquire, $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2, \mathrm{CH} 3, \mathrm{CH} 4$, acquire, $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2, \mathrm{CH} 3, \mathrm{CH} 4 \ldots$ |
| 1 | 0 | 1 | acquire, $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2, \mathrm{CH} 3, \mathrm{CH} 4, \mathrm{CH} 5$, acquire, $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2, \mathrm{CH} 3, \mathrm{CH} 4, \mathrm{CH} 5 . .$. |
| 1 | 1 | 0 | acquire, $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2, \mathrm{CH} 3, \mathrm{CH} 4, \mathrm{CH} 5$, acquire, $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2, \mathrm{CH} 3, \mathrm{CH} 4, \mathrm{CH} 5 . .$. |
| 1 | 1 | 1 | acquire, $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2, \mathrm{CH} 3, \mathrm{CH} 4, \mathrm{CH} 5$, acquire, $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2, \mathrm{CH} 3, \mathrm{CH} 4, \mathrm{CH} 5 . .$. |

## APPLICATIONS INFORMATION

LTC1408-12 inputs can be driven directly. As source impedance increases, so will acquisition time. For minimum acquisition time with high source impedance, a buffer amplifier must be used. The main requirement is that the amplifier driving the analog input(s) must settle after the small current spike before the next conversion starts (the time allowed for settling must be at least 39ns for full throughput rate). Also keep in mind while choosing an input amplifier the amount of noise and harmonic distortion added by the amplifier.

## CHOOSING AN INPUT AMPLIFIER

Choosing an input amplifier is easy if a few requirements are taken into consideration. First, to limit the magnitude of the voltage spike seen by the amplifier from charging the sampling capacitor, choose an amplifier that has a low output impedance (<100 ) at the closed-loop bandwidth frequency. For example, if an amplifier is used in a gain of 1 and has a unity-gain bandwidth of 50 MHz , then the output impedance at 50 MHz must be less than $100 \Omega$. The second requirement is that the closed-loop bandwidth must be greater than 40 MHz to ensure adequate smallsignal settling for full throughput rate. If slower op amps are used, more time for settling can be provided by increasing the time between conversions. The best choice for an op amp to drive the LTC1408-12 depends on the application. Generally, applications fall into two categories: AC applications where dynamic specifications are most critical and time domain applications where DC accuracy and settling time are most critical. The following list is a summary of the op amps that are suitable for driving the LTC1408-12. (More detailed information is available in the Linear Technology Databooks and on the website at www.linear.com.)

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LTC1566-1: Low Noise 2.3MHz Continuous Time Lowpass Filter.
LT ${ }^{\circledR}$ 1630: Dual 30MHz Rail-to-Rail Voltage FB Amplifier. 2.7 V to $\pm 15 \mathrm{~V}$ supplies. Very high $\mathrm{AVoL}_{\mathrm{V}}, 500 \mu \mathrm{~V}$ offset and 520 ns settling to 0.5 LSB for a 4 V swing. THD and noise are -93 dB to 40 kHz and below 1 LSB to 320 kHz ( $\mathrm{A}_{\mathrm{V}}=1$, $2 \mathrm{~V}_{\text {P-p into }} 1 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}$ ), making the part excellent for AC applications (to $1 / 3$ Nyquist) where rail-to-rail performance is desired. Quad version is available as LT1631.

LT1632: Dual 45MHz Rail-to-Rail Voltage FB Amplifier. 2.7 V to $\pm 15 \mathrm{~V}$ supplies. Very high $\mathrm{A}_{\mathrm{VOL}}, 1.5 \mathrm{mV}$ offset and 400 ns settling to 0.5 LSB for a 4 V swing. It is suitable for applications with a single 5V supply. THD and noise are -93 dB to 40 kHz and below 1 LSB to $800 \mathrm{kHz}\left(\mathrm{A}_{V}=1\right.$, $2 \mathrm{~V}_{\text {P-p }}$ into $1 \mathrm{k} \Omega, \mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}$ ), making the part excellent for AC applications where rail-to-rail performance is desired. Quad version is available as LT1633.

LT1801: 80 MHz GBWP, -75 dBc at $500 \mathrm{kHz}, 2 \mathrm{~mA} / \mathrm{ampli}-$ fier, $8.5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$.
LT1806/LT1807: 325 MHz GBWP, -80 dBc distortion at 5 MHz , unity gain stable, rail-to-rail in and out, $10 \mathrm{~mA} /$ amplifier, $3.5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$.
LT1810: 180MHz GBWP, -90 dBc distortion at 5 MHz , unity gain stable, rail-to-rail in and out, $15 \mathrm{~mA} /$ amplifier, $16 \mathrm{nV} / \sqrt{\mathrm{Hz}}$.

LT1818/LT1819: 400MHz, 2500V/ $\mu \mathrm{s}$, 9mA, Single/Dual Voltage Mode Operational Amplifier.
LT6200: 165 MHz GBWP, -85 dBc distortion at 1 MHz , unity gain stable, rail-to-rail in and out, $15 \mathrm{~mA} /$ amplifier, $0.95 \mathrm{nV} / \sqrt{\mathrm{Hz}}$.

LT6203: 100MHz GBWP, -80 dBc distortion at 1 MHz , unity gain stable, rail-to-rail in and out, $3 \mathrm{~mA} /$ amplifier, $1.9 \mathrm{nV} / \sqrt{\mathrm{Hz}}$.

LT6600: Amplifier/Filter Differential In/Out with 10MHz Cutoff frequency.

## APPLICATIONS INFORMATION

## INPUT FILTERING AND SOURCE IMPEDANCE

The noise and the distortion of the input amplifier and other circuitry must be considered since they will add to the LTC1408-12 noise and distortion. The small-signal bandwidth of the sample-and-hold circuit is 50 MHz . Any noise or distortion products that are present at the analog inputs will be summed over this entire bandwidth. Noisy input circuitry should be filtered prior to the analog inputs to minimize noise. A simple 1-pole RC filter is sufficient for many applications. For example, Figure 1 shows a 47pF capacitor from $\mathrm{CHO}^{+}$to ground and a $51 \Omega$ source resistor to limit the net input bandwidth to 30 MHz . The 47 pF capacitoralso acts as a charge reservoir for the input sample-and-hold and isolates the ADC input from sampling-glitch sensitive circuitry. High quality capacitors and resistors should be used since these components can add distortion. NPO and silvermica type dielectric capacitors have excellent linearity. Carbon surface mount resistors can generate distortion from self heating and from damage that may occur during soldering. Metal film surface mount resistors are much less susceptible to both problems. When high amplitude unwanted signals are close in frequency to the desired signal frequency a multiple pole filter is required.

High external source resistance, combined with 13pF of input capacitance, will reduce the rated 50 MHz input bandwidth and increase acquisition time beyond 39ns.


Figure 1. RC Input Filter

## INPUT RANGE

The analog inputs of the LTC1408-12 may be driven fully differentially with a single supply. Either input may swing up to $\mathrm{V}_{\mathrm{CC}}$, provided the differential swing is no greater than 2.5 V with BIP (Pin 29) Low, or $\pm 1.25 \mathrm{~V}$ with (BIP Pin 29) High. The 0 V to 2.5 V range is also ideally suited for singleended input use with single supply applications. The common mode range of the inputs extend from ground to the supply voltage $\mathrm{V}_{\mathrm{CC}}$. If the difference between the $\mathrm{CH}^{+}$ and $\mathrm{CH}^{-}$at any input pair exceeds 2.5 V (unipolar) or 1.25 V (bipolar), the output code will stay fixed at positive fullscale, and if this difference goes below OV (unipolar) or 1.25 V (bipolar), the output code will stay fixed at negative full-scale.

## INTERNAL REFERENCE

The LTC1408-12 has an on-chip, temperature compensated, bandgap reference that is factory trimmed to 2.5 V to obtain a precise 2.5 V input span. The reference amplifier output $\mathrm{V}_{\text {REF }}$, (Pin 23) must be bypassed with a capacitor to ground. The reference amplifier is stable with capacitors of $1 \mu \mathrm{~F}$ or greater. For the best noise performance, a $10 \mu \mathrm{~F}$ ceramic or a $10 \mu \mathrm{~F}$ tantalum in parallel with a $0.1 \mu \mathrm{~F}$ ceramic is recommended. The $\mathrm{V}_{\text {REF }}$ pin can be overdriven with an external reference as shown in Figure 2. The voltage of the external reference must be higher than the 2.5 V of the open-drain P-channel output of the internal reference. The recommended range for an external reference is 2.55 V to $\mathrm{V}_{\mathrm{DD}}$. An external reference at 2.55 V will see a DC quiescent load of 0.75 mA and as much as 3 mA during conversion.


Figure 2. Overdriving $V_{\text {REF }}$ Pin with an External Reference

## APPLICATIONS INFORMATION

## INPUT SPAN VERSUS REFERENCE VOLTAGE

The differential input range has a unipolar voltage span that equals the difference between the voltage at the reference buffer output $\mathrm{V}_{\text {REF }}$ (Pin 23) and the voltage at ground. The differential input range of the ADC is 0 V to 2.5 V when using the internal reference. The internal ADC is referenced to these two nodes. This relationship also holds true with an external reference.

## DIFFERENTIAL INPUTS

The ADC will always convert the difference of $\mathrm{CH}^{+}$minus $\mathrm{CH}^{-}$, independent of the common mode voltage at any pair of inputs. The common mode rejection holds up at high frequencies (see Figure 3.) The only requirement is that both inputs not go below ground or exceed $\mathrm{V}_{\mathrm{DD}}$.


Figure 3. CMRR vs Frequency
Integral nonlinearity errors (INL) and differential nonlinearity errors (DNL) are largely independent of the common mode voltage. However, the offset error will vary. DC CMRR is typically better than -90 dB .

Figure 4 shows the ideal input/output characteristics for the LTC1408-12 in unipolar mode (BIP = Low). The code transitions occur midway between successive integer LSB values (i.e., $0.5 \mathrm{LSB}, 1.5 \mathrm{LSB}, 2.5 \mathrm{LSB}, \mathrm{FS}-1.5 \mathrm{LSB}$ ). The output code is straight binary with $1 \mathrm{LSB}=2.5 \mathrm{~V} / 4096=$ $610 \mu \mathrm{~V}$ for the LTC1408-12. The LTC1408-12 has 0.2 LSB RMS of Gaussian white noise.


Figure 4. LTC1408-12 Transfer Characteristic in Unipolar Mode (BIP = Low)

Figure 5 shows the ideal input/output characteristics for the LTC1408-12 in bipolar mode (BIP = High). The code transitions occur midway between successive integer LSB values (i.e., $0.5 \mathrm{LSB}, 1.5 \mathrm{LSB}, 2.5 \mathrm{LSB}, \mathrm{FS}-1.5 \mathrm{LSB}$ ). The output code is 2 's complement with $1 \mathrm{LSB}=2.5 \mathrm{~V} / 4096=$ $610 \mu \mathrm{~V}$ for the LTC1408-12. The LTC1408-12 has 0.2 LSB RMS of Gaussian white noise.


Figure 5. LTC1408-12 Transfer Characteristic in Bipolar Mode (BIP = High)

## APPLICATIONS INFORMATION

## POWER-DOWN MODES

Upon power-up, the LTC1408-12 is initialized to the active state and is ready for conversion. The Nap and Sleep mode waveforms show the power down modes for the LTC1408-12. The SCK and CONV inputs control the power down modes (see Timing Diagrams). Two rising edges at CONV, without any intervening rising edges at SCK, put the LTC1408-12 in Nap mode and the power consumption drops from 15 mW to 3.3 mW . The internal reference remains powered in Nap mode. One or more rising edges at SCK wake up the LTC1408-12 very quickly and CONV can start an accurate conversion within a clock cycle. Four rising edges at CONV, without any intervening rising edges at SCK, put the LTC1408-12 in Sleep mode and the power consumption drops from 15 mW to $6 \mu \mathrm{~W}$. One or more rising edges at SCK wake up the LTC1408-12 for operation. The internal reference ( $\mathrm{V}_{\text {REF }}$ ) takes 2 ms to slew and settle with a $10 \mu \mathrm{~F}$ load. Using sleep mode more frequently compromises the accuracy of the output data. Note that for slower conversion rates, the Nap and Sleep modes can be used for substantial reductions in power consumption.

## DIGITAL INTERFACE

The LTC1408-12 has a 3-wire SPI (Serial Peripheral Interface) interface. The SCK and CONV inputs and SDO output implement this interface. The SCK and CONV inputs accept swings from 3 V logic and are TTL compatible, if the logic swing does not exceed $V_{D D}$. A detailed description of the three serial port signals follows:

## Conversion Start Input (CONV)

The rising edge of CONV starts a conversion, but subsequent rising edges at CONV are ignored by the LTC1408-12 until the following 96 SCK rising edges have occurred. The duty cycle of CONV can be arbitrarily chosen to be used as a frame sync signal for the processor serial port. A simple approach to generate CONV is to create a pulse that is one SCK wide to drive the LTC1408-12 and then buffer this signal to drive the frame sync input of the processor serial port. It is good practice to drive the LTC1408-12 CONV input first to avoid digital noise interference during the sample-to-hold transition triggered by CONV at the start of conversion. It is also good practice to keep the width of the low portion of the CONV signal greater than 15 ns to avoid introducing glitches in the front end of the ADC just before the sample-and-hold goes into Hold mode at the rising edge of CONV.

## Minimizing Jitter on the CONV Input

In high speed applications where high amplitude sine waves above 100 kHz are sampled, the CONV signal must have as little jitter as possible (10ps or less). The square wave output of a common crystal clock module usually meets this requirement. The challenge is to generate a CONV signal from this crystal clock without jitter corruption from other digital circuits in the system. A clock divider and any gates in the signal path from the crystal clock to the CONV input should not share the same integrated circuit with other parts of the system. The SCK and CONV inputs should be driven first, with digital buffers

## APPLICATIONS INFORMATION

used to drive the serial port interface. Also note that the master clock in the DSP may already be corrupted with jitter, even if it comes directly from the DSP crystal. Another problem with high speed processor clocks is that they often use a low cost, low speed crystal (i.e., 10MHz) to generate a fast, but jittery, phase-locked-loop system clock (i.e., 40MHz). The jitter in these PLL-generated high speed clocks can be several nanoseconds. Note that if you choose to use the frame sync signal generated by the DSP port, this signal will have the same jitter of the DSP's master clock.

The Typical Application Figure on page 20 shows a circuit for level-shifting and squaring the output from an RF signal generator or other low-jitter source. A single D-type flip flop is used to generate the CONV signal to the LTC1408-12. Re-timing the master clock signal eliminates clock jitter introduced by the controlling device (DSP, FPGA, etc.) Both the inverter and flip flop must be treated as analog components and should be powered from a clean analog supply.

## Serial Clock Input (SCK)

The rising edge of SCK advances the conversion process and also udpates each bit in the SDO data stream. After CONV rises, the third rising edge of SCK sends out up to six sets of 12 data bits, with the MSB sent first. A simple approach is to generate SCK to drive the LTC1408-12 first and then buffer this signal with the appropriate number of inverters to drive the serial clock input of the processor serial port. Use the falling edge of the clock to latch data from the Serial Data Output (SDO) into your processor serial port. The 12-bit Serial Data will be received in six 16 -bit words with 96 or more clocks per frame sync. If fewer than 6 channels are selected by SELO-SEL2 for conversion, then 16 clocks are needed per channel to convert the analog inputs and read out the resulting data
after the next convert pulse. It is good practice to drive the LTC1408-12 SCK input first to avoid digital noise interference during the internal bit comparison decision by the internal high speed comparator. Unlike the CONV input, the SCK input is not sensitive to jitter because the input signal is already sampled and held constant.

## Serial Data Output (SDO)

Upon power-up, the SDO output is automatically reset to the high impedance state. The SDO output remains in high impedance until a new conversion is started. SDO sends out up to six sets of 12 bits in the output data stream after the third rising edge of SCK after the start of conversion with the rising edge of CONV. The six or fewer 12-bit words are separated by two don't care bits and two clock cycles in high impedance mode. Please note the delay specification from SCK to a valid SDO. SDO is always guaranteed to be valid by the next rising edge of SCK. The 16 - 96-bit output data stream is compatible with the 16-bit or 32-bit serial port of most processors.

## BOARD LAYOUT AND BYPASSING

Wire wrap boards are not recommended for high resolution and/or high speed A/D converters. To obtain the best performance from the LTC1408-12, a printed circuit board with ground plane is required. Layout for the printed circuit board should ensure that digital and analog signal lines are separated as much as possible. In particular, care should be taken not to run any digital track alongside an analog signal track. If optimum phase match between the inputs is desired, the length of the twelve input wires of the six input channels should be kept matched. But each pair of input wires to the six input channels should be kept separated by a ground trace to avoid high frequency crosstalk between channels.

## APPLICATIONS InFORMATION

High quality tantalum and ceramic bypass capacitors should be used at the $V_{C C}, V_{D D}$ and $V_{\text {REF }}$ pins as shown in the Block Diagram on the first page of this data sheet. For optimum performance, a $10 \mu \mathrm{~F}$ surface mount tantalum capacitor with a $0.1 \mu \mathrm{~F}$ ceramic is recommended for the $V_{C C}, V_{D D}$ and $V_{\text {REF }}$ pins. Alternatively, $10 \mu \mathrm{~F}$ ceramic chip capacitors such as X5R or X7R may be used. The capacitors must be located as close to the pins as possible. The traces connecting the pins and the bypass capacitors must be kept short and should be made as wide as possible. The $V_{C C}$ and $V_{D D}$ bypass capacitor returns to the ground plane and the $\mathrm{V}_{\text {REF }}$ bypass capacitor returns to the Pin 22. Care should be taken to place the $0.1 \mu \mathrm{~F} V_{C C}$ and $V_{D D}$ bypass capacitor as close to Pins 24 and 25 as possible.

Figure 6 shows the recommended system ground connections. All analog circuitry grounds should be terminated at the LTC1408-12 Exposed Pad. The ground return from the LTC1408-12 to the power supply should be low impedance for noise-free operation. The Exposed Pad of the 32pin QFN package is also internally tied to the ground pads. The Exposed Pad should be soldered on the PC board to reduce ground connection inductance. All ground pins (GND, DGND, OGND) must be connected directly to the same ground plane under the LTC1408-12.


Figure 6. Recommended Layout

## HARDWARE INTERFACE TO TMS320C54x

The LTC1408-12 is a serial output ADC whose interface has been designed for high speed buffered serial ports in fast digital signal processors (DSPs). Figure 7 shows an example of this interface using a TMS320C54X.
The buffered serial port in the TMS320C54x has direct access to a 2 kB segment of memory. The ADC's serial data can be collected in two alternating 1kB segments, in real time, at the full 600ksps conversion rate of the LTC1408-12. The DSP assembly code sets frame sync mode at the BFSR pin to accept an external positive going pulse and the serial clock at the BCLKR pin to accept an external positive edge clock. Buffers near the LTC1408-12 may be added to drive long tracks to the DSP to prevent corruption of the signal to LTC1408-12. This configuration is adequate to traverse a typical system board, but source resistors at the buffer outputs and termination resistors at the DSP, may be needed to match the characteristic impedance of very long transmission lines. If you need to terminate the SDO transmission line, buffer it first with one or two 74ACxx gates. The TTL threshold inputs of the DSP port respond properly to the 3 V swing used with the LTC1408-12.


Figure 7. DSP Serial Interface to TMS320C54x

PACKAGE DESCRIPTION

## UH Package

32-Lead Plastic QFN (5mm x 5mm)
(Reference LTC DWG \# 05-08-1693)


RECOMMENDED SOLDER PAD LAYOUT
APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED


NOTE:

1. DRAWING PROPOSED TO BE A JEDEC PACKAGE OUTLINE

MO-220 VARIATION WHHD-(X) (TO BE APPROVED)
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS
4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE

MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.20 mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION

ON THE TOP AND BOTTOM OF PACKAGE

## RELATED PARTS

| PART NUMBER | DESCRIPTION | COMMENTS |
| :---: | :---: | :---: |
| ADCs |  |  |
| LTC1402 | 12-Bit, 2.2Msps Serial ADC | 5 V or $\pm 5 \mathrm{~V}$ Supply, 4.096V or $\pm 2.5 \mathrm{~V}$ Span |
| LTC1403/LTC1403A | 12-/14-Bit, 2.8Msps Serial ADC | 3V, 15mW, Unipolar Inputs, MSOP Package |
| LTC1403-1/LTC1403A-1 | 12-/14-Bit, 2.8Msps Serial ADC | 3V, 15mW, Bipolar Inputs, MSOP Package |
| LTC1405 | 12-Bit, 5Msps Parallel ADC | 5 V , Selectable Spans, 115mW |
| LTC1407/LTC1407A | 12-/14-Bit, 3Msps Simultaneous Sampling ADC | 3V, 14mW, 2-Channel Unipolar Input Range |
| LTC1407-1/LTC1407A-1 | 12-/14-Bit, 3Msps Simultaneous Sampling ADC | 3V, 14mW, 2-Channel Bipolar Input Range |
| LTC1408 | 14-Bit, 600ksps Simultaneous Sampling ADC | 3V, 15mW, Selectable Bipolar (Unipolar Input, Six Differential Inputs) |
| LTC1411 | 14-Bit, 2.5Msps Parallel ADC | 5V, Selectable Spans, 80dB SINAD |
| LTC1412 | 12-Bit, 3Msps Parallel ADC | $\pm 5 \mathrm{~V}$ Supply, $\pm 2.5 \mathrm{~V}$ Span, 72 dB SINAD |
| LTC1420 | 12-Bit, 10Msps Parallel ADC | 5 V , Selectable Spans, 72dB SINAD |
| LTC1608 | 16-Bit, 500ksps Parallel ADC | $\pm 5 \mathrm{~V}$ Supply, $\pm 2.5 \mathrm{~V}$ Span, 90 dB SINAD |
| LTC1609 | 16-Bit, 250ksps Serial ADC | 5 V Configurable Bipolar/Unipolar Inputs |
| LTC1864/LTC1865 LTC1864L/LTC1865L | 16-Bit, 250ksps 1-/2-Channel Serial ADCs | 5 V or 3V (L-Version), Micropower, MSOP Package |
| DACs |  |  |
| LTC1592 | 16-Bit, Serial SoftSpan ${ }^{\text {TM }} I_{\text {OUT }}$ DAC | $\pm 1$ LSB INL/DNL, Software Selectable Spans |
| LTC1666/LTC1667 <br> LTC1668 | 12-/14-/16-Bit, 50Msps DAC | 87dB SFDR, 20ns Settling Time |
| References |  |  |
| LT1460-2.5 | Micropower Series Voltage Reference | 0.10\% Initial Accuracy, 10ppm Drift |
| LT1461-2.5 | Precision Voltage Reference | 0.04\% Initial Accuracy, 3ppm Drift |
| LT1790-2.5 | Micropower Series Reference in SOT-23 | 0.05\% Initial Accuracy, 10ppm Drift |

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## TYPICAL APPLICATION

## Low-Jitter Clock Timing with RF Sine Generator Using Clock Squaring/Level Shifting Circuit and Re-Timing Flip-Flop



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